Supporting Information for

Tuning Valley-Ohmic Contact and Interfacial Electronic Properties in Valley-Polarized Semiconductor/Dirac Semimetal Heterostructures

Hao Guo,^{ab} Yongqian Zhu,^{ac} Jinbo Pan,^{*ac} Shixuan Du^{acd}

^a Beijing National Laboratory for Condensed Matter Physics, Institute of Physics, Chinese Academy of Sciences, Beijing 100190. E-mail: jbpan@iphy.ac.cn

^b School of Urban Construction, Hebei Normal University of Science & Technology, Qinhuangdao 066004, China.

^c School of Physics, University of Chinese Academy of Sciences, Beijing 100049, China.

^d Songshan Lake Materials Laboratory, Dongguan 523808 Guangdong, China.



Fig. S1. The lattice structures and band structures of the Dirac semimetals X. The top and side views of (a) graphene, (b) germanene, and (c) SiGe, respectively. The pristine and strained band structures of (d,g) graphene, (f,i) respectively. 0 (e,h) germanene, and SiGe, The Fermi level is set to eV.



Fig. S2. Different stacking patterns of X/GdI_2 (X = graphene, germanene, and SiGe) vdWHs. The top and side views of (a) T1-graphene/GdI₂, (b) T2-graphene/GdI₂, (c) T3-graphene/GdI₂, (d) T1-germanene/GdI₂, (e) T2-germanene/GdI₂, (f) T3-germanene/GdI₂, (g) T1-SiGe/GdI₂, (h)T2-SiGe/GdI₂, and (i) T3-SiGe/GdI₂ vdWHs. The interlayer distances of these vdWHs are marked in their side views.

vdWHs	Stacking Patterns	Total energy (eV)	Binding energy (eV/atom)
graphene/GdI ₂	T1	-307.192	-0.954
	T2	-307.170	-0.948
	T3*	-307.192	-0.954
	T1	-119.759	-0.937
germanene/GdI2	T2	-119.473	-0.865
	Т3	-119.544	-0.883
SiGe/GdI ₂	T1	-122.028	-0.932
	T2	-121.743	-0.860
	Т3	-121.778	-0.869

Table S1. The total energies and binding energies of X/GdI_2 (X = graphene, germanene, and SiGe) vdWHs withdifferent stacking patterns.

* The optimized atomic alignment of T3-type graphene/GdI₂ is consistent with that of T1-type graphene/GdI₂, leading to identical total energy and binding energy for both types.



Fig. S3. Band structures of the isolated GdI_2 monolayer. Band structure of the GdI_2 monolayer calculated using (a) HSE06 with SOC and (b) PBE+U without SOC. Band structure of the GdI_2 monolayer with (c) positive and (d) negative magnetic moment along the *z*-direction in the presence of SOC, respectively. The pink and orange lines represent the spin-up and spin-down channels, respectively. The Fermi level is set to 0 eV.

As shown in **Fig. S3a**, the band gap value of the GdI₂ monolayer is 1.10 eV by the HSE06 method with SOC. In the absence of SOC, the band structure of the GdI₂ monolayer calculated by the PBE+U method, as shown in **Fig. S3b**, reveals that the top valence band and the bottom conduction band are contributed by the spin-up and spin-down channels, respectively, indicating that the GdI₂ monolayer belongs to bipolar magnetic semiconductor. When considering the SOC, as shown in **Fig. S3c**, it is obvious that the energy value at the K point in the top valence band is larger than that at the K' point, showing the spontaneous valley polarization due to the time reversal symmetry broken. The calculated valley splitting of the GdI₂ monolayer is 147 meV, which is in good agreement with previous report (149 meV)¹ and larger than that of GdF₂ (55 meV), GdCl₂ (38 meV), and GdBr₂ (82 meV)². The SOC effect exerts a significantly stronger influence on the valence band of the monolayer GdI₂ compared to the conduction band, resulting in a transformation from an n-type indirect bandgap (0.497 eV) semiconductor. Furthermore, reversing the magnetization of Gd atoms from +*z* to -*z* direction, as shown in **Fig. S3d**, the top valence band and the bottom conduction band are transformed to be contributed by the spin-down and spin-up channels, respectively. Meanwhile, the energy at the K point in the top valence band is 147 meV lower than that at the K' point. The result indicates that reversing the magnetization direction has caused the inversion of both the spin and valley polarization of the GdI₂ monolayer .



Fig. S4. Projected band structures of X/**GdI**₂ **vdWHs.** Projected band structures showing the spin-up and spindown channels for (a) graphene/GdI₂, (b) germanene/GdI₂, and (c) SiGe/GdI₂ in the absence of SOC, respectively. The pink, orange and blue lines represent the contributions from the spin-up channel of GdI₂, the spin-down channel of GdI₂, and *X*, respectively. The illustrations provide enlarged views of the 2D Dirac cones and their corresponding band gaps. The Fermi level is set to 0 eV.

When SOC is not considered, the projected band structures with spin-up and spin-down channels of X/GdI_2 are shown in Fig. S4a-c. It is clear that the Dirac cones of 2D semimetals X shift downward relative to the Fermi level of the X/GdI_2 vdWHs. The direction of the Dirac cone shift in X/GdI_2 is opposite to that observed in RuCl₂/graphene and NbSe₂/graphene vdWHs³, due to the opposite directions of charge transfer. Specifically, the Dirac point of Dirac semimetals X in graphene/GdI₂, germanene/GdI₂ and SiGe/GdI₂ deviate downward from the Fermi level by about 188 meV, 179 meV and 185 meV, respectively. More interestingly, the Dirac cones of the Dirac semimetals exhibit opened band gaps due to the effects of the vdW interaction between GdI_2 and Dirac semimetals X. The spinup (spin-down) channel of GdI₂ induces band gaps of 7 meV (4 meV) in graphene, 30 meV (4 meV) in germanene, and 19 meV (10 meV) in SiGe, respectively. The spin-up channel of GdI2 causes the Dirac semimetals to open a relatively larger bandgap, further demonstrating that the spin-up channel of GdI₂ has a greater effect on the electronic structure of the Dirac semimetals.



Fig. S5. Side views and projected band structures of SiGe/GdI₂ vdWH with different spontaneous polarization. (a) Side views of the SiGe/GdI₂ vdWH with SiGe polarized upward ($P\uparrow$) and downward ($P\downarrow$), respectively. Projected band structures of SiGe-P \downarrow /GdI₂ vdWHs with (b) spin-up channel (pink lines) and (c) spin-down channel (orange lines) in the absence of SOC, respectively. Projected band structures of SiGe-P \downarrow /GdI₂ vdWHs with (d) positive and (e) negative magnetic moment along the *z*-direction in the presence of SOC, respectively. The red and blue lines represent the contributions from GdI₂ and *X*, respectively. The Fermi level is set to 0 eV.

It is noteworthy that the SiGe monolayer is a 2D ferroelectric semimetal with out-of-plane spontaneous polarization⁴. The SiGe monolayer has also been employed in the design of ferroelectric field-effect transistors (FeFETs)⁵⁻⁸. Therefore, it is crucial to investigate the impact of ferroelectric polarization inversion in SiGe on the band structure and contact barrier of the SiGe/GdI₂ vdWH. The side views of SiGe/GdI₂ vdWH with SiGe polarized upward (P↑) and downward (P↓) are shown in **Fig. S5a**. When the ferroelectric polarization direction of SiGe is reversed from upward (P↑) to downward (P↓), as shown in **Fig. S5b,c**, the open band gap of Dirac points at the K point and K' points increases from 19 meV (10 meV) to 132 meV (78 meV) in the spin-up (spin-down) channel of GdI₂, respectively, meaning that the interlayer interactions are stronger when Ge atoms are close to GdI₂. When SOC is considered, SiGe/GdI₂ vdWH remains a p-type overall Ohmic contact with the p-type SBHs of -240 meV and -85 meV at the K and K' points, respectively, even as the polarization direction of SiGe does not change the intrinsic contact type of the SiGe/GdI₂ vdWH. Therefore, unless otherwise specified, the polarization direction of SiGe is assumed to be upward in this work.

The equilibrium interlayer distances of graphene/GdI₂, germanene/GdI₂, and SiGe/GdI₂ vdWHs are 3.61 Å, 3.24 Å, and 3.27Å, respectively. The change of interlayer distance (Δ d) is defined as:

$$\Delta d = d_{int} - d_0 \tag{1}$$

where d_{int} and d₀ refer to the changed and the equilibrium interlayer distances of X/GdI₂ vdWHs, respectively.



Fig. S6. Projected band structures of graphene/GdI₂ vdWH with SOC under different interlayer distances. The red and blue lines in the band structures represent the contributions from GdI₂ and graphene, respectively. The Fermi level is set to 0 eV. The fully relaxed interlayer distance of graphene/GdI₂ is 3.61 Å ($\Delta d = \pm 0.0$ Å).



Fig. S7. Projected band structures of germanene/GdI₂ vdWH with SOC under different interlayer distances. The red and blue lines in the band structures represent the contributions from GdI₂ and germanene, respectively. The Fermi level is set to 0 eV. The fully relaxed interlayer distance of germanene/GdI₂ is 3.24 Å ($\Delta d = \pm 0.0$ Å).



Fig. S8. Projected band structures of SiGe/GdI₂ vdWH with SOC under different interlayer distances. The red and blue lines in the band structures represent the contributions from GdI₂ and SiGe, respectively. The Fermi level is set to 0 eV. The fully relaxed interlayer distance of SiGe/GdI₂ is 3.27 Å ($\Delta d = \pm 0.0$ Å).



Fig. S9. Projected band structures of graphene/GdI₂ vdWH with electron and hole doping from -0.2 e to +1.0 e. Positive and negative values indicate electron and hole doping, respectively. The red and blue lines in the band structures represent the contributions from GdI_2 and graphene, respectively. The Fermi level is set to 0 eV.



Fig. S10. Projected band structures of germanene/GdI₂ vdWH with electron doping from 0 e to 0.6 e. The red and blue lines in the band structures represent the contributions from GdI_2 and germanene, respectively. The Fermi level is set to 0 eV.



Fig. S11. Projected band structures of SiGe/GdI₂ vdWH with electron doping from 0 e to 0.6 e. The red and blue lines in the band structures represent the contributions from GdI_2 and SiGe, respectively. The Fermi level is set to 0 eV.

References

1 H.-X. Cheng, J. Zhou, W. Ji, et al., *Physical Review B*, 2021, **103**, 125121.

- 2 K. Sheng, H. K. Yuan and Z. Y. Wang, Physical Chemistry Chemical Physics, 2022, 24, 3865-3874.
- 3 X. Feng, C. S. Lau, S. J. Liang, et al., Advanced Functional Materials, 2023, 34, 2309848.
- 4 C. J. Yao, H. F. Huang, Y. Yao, et al., Journal of Physics: Condensed Matter, 2021, 33, 145302.
- 5 A. Vinod, P. Kumar and B. Bhowmick, AEU International Journal of Electronics and Communications, 2019, 107, 257-263.
- 6 M. Lederer, F. Muller, K. Kuhnel, et al., IEEE Electron Device Letters, 2020, 41, 1762-1765.
- 7 N. Thoti and Y. Li, Japanese Journal of Applied Physics, 2021, 60, 054001.
- 8 S. Singh, R. Gupta, Priyanka, et al., Silicon, 2022, 14, 11015-11025.